

INGESYS™ IC3

PRODUCT OVERVIEW



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1 INTRODUCTION

INGESYS[™] IC3 is a scalable, flexible, high-performance automation platform. Based on the concept of Programmable Automation Controllers (PACs), it fulfils the requirements of the process industry with a complete solution for demanding automation applications. A comprehensive suite of processors with increasing performance and I/Os modules increases the performance, quality and profitability of your industrial process.

The *INGESYS*[™] IC3 controller optimises the integration of real-time multitasking control and the reliability of embedded platforms with the openness and tools offered by the new PC based solutions for the data intensive management. A wide range of programming techniques (IEC61131 programming tool based on CODESYS, C++, MATLAB®/SIMULINK®) makes it possible to increase the performance and profitability of the control engineer throughout the different phases of plant automation (programming, commissioning and maintenance).

A modular design fulfilling industry requirements (extreme ambient and vibrational conditions, extended life time, EMC, etc.) guarantees the achievement of low failure rates and high availability.

A complete range of network and fieldbus communication protocols based on standards facilitate the integration of *INGESYS™* IC3 with upper automation levels and with low-level field devices.

An internal distributed architecture based on a real-time optical fibre bus makes it possible to optimally adapt the control system to the process's requirements.

INGESYS[™] IC3 PAC Controller Highlights:

- Control processors and I/O modules designed to fulfill the demands of different application sectors with competitive solutions
- Realtime control
- Advanced programming (IEC 61131-3, C++, MATLAB®/SIMULINK®)
- Integrated PC functional features (Web server, FTP, Flash-based file system, etc.)
- Integrated industry standard de facto Ethernet protocols
- Complete range of industrial fieldbuses (CANopen, Profibus DP, Interbus-S, Ethercat, etc.)
- RTU functionality based on a complete range of standard protocols (IEC 60870-5-101, IEC 60870-5-104, DNP3, IEC61850, etc.)
- Vibrations / Shock resistance conforming to EN60068-2-6/EN60068-2-27
- EMC Immunity /emission conforming to EN61000-6-2/EN61000-6-4

Applications:

- Renewable energies (Wind, Hydroelectric, Solar)
- Industry automation
- Transport
- Power grid automation

2 RACKS

The set of IC3 racks provides mechanical support and electrical interconnection to the *INGESYS*[™] IC3 controller modules.



Two types of racks are available:

a) Racks including a reserved slot for power supply modules. Designed for CPU or bus terminal modules powered at 3,3V or 5,0V that require an external power supply module.

References					
IC3501 Power supply + CPU + 16 I/O one-slot modules					
IC3503	Power supply + CPU + 4 I/O one-slot modules				
IC3504	Power supply + CPU + 8 I/O one-slot modules				
IC3505	Power supply + CPU + 2 I/O one-slot modules				
IC3507	Power supply + CPU + 4VC + 8 I/O one-slot modules				
IC3509	2 Power supply + CPU + 2 I/O one-slot modules				
IC3510	2 Power supply + 2 CPU/header + 12 I/O one-slot modules				
IC3516	2 Power supply + CPU + 8 I/O one-slot modules				

b) Racks not including a reserved slot for power supply modules. Designed for CPU or bus terminal modules powered at 24V that do not require an external power supply module.

References					
IC3511 CPU/header + 8 I/O one-slot modules					
IC3512	CPU/header + 4 I/O one-slot modules				
IC3513	CPU/header + 2 I/O one-slot modules				
IC3515	CPU/header + 6 I/O one-slot modules				

3 POWER SUPPLY MODULES

IC360x power supply modules feed power to the whole system via the backplane. Different input voltages (24Vdc, 125Vdc or 220Vac) are available, depending on the installation requirements.

These modules have been designed for use in the harshest of environments, where low dissipation and high temperature support are needed. For this purpose, new semiconductor and transformer design techniques have been used.

IC360x power supply modules are also prepared for redundancy operation. Two power supplies can be connected in parallel. In case one fails, the second one immediately takes control without any voltage drop. The LEDs of the malfunctioning power supply module will switch off, so that the user can identify and replace it.

Redundancy operation is the well-known N+1 mode. That means that there is neither current sharing nor power sharing. When two power supply modules are connected in parallel the maximum output current is still 5A per output.

- 24Vdc, 125Vdc, 220Vac
- Status indication LEDs
- Status monitoring from processor module
- High temperature operation
- N + 1 redundancy support
- Long-life design under extreme operation conditions

References					
IC3602	Power supply 24Vdc input				
IC3603	Power supply 88-300Vdc / 85-250Vac input				



	IC3602	IC3603					
Electrical							
Input Voltage	14,4Vdc to 31,2Vdc	88Vdc to 300Vdc 85Vac to 285Vac					
Max. Input Current	3,2Adc	0,75Adc 0,70Aac					
Output Voltage	3,3V / 5,	0V					
Max. Output current							
3,3 V	5A						
5,0 V	5A						
Max. Dissipated Power	12W	10W					
Isolation							
Input-Output	2000Vac @)) 60s					
Input-Earth	2000Vdc @ 60s						
Additional Featur	es						
Reverse input voltage prote	ection						
Input, 3,3V and 5,0V status	indication LEDs						
Input and output voltage su	pervision						
Power fail indication to proc	cessor module						
N + 1 redundancy support	N + 1 redundancy support						
Mechanical							
Dimensions (WxHxD)	n x 150,5mm						
Weight	540g						
Climatic							
Operating Temperature	-40°C to + 70°C						
Storage Temperature	-40°C to + 85°C						
Relative Humidity	5% to 95% w/o condensing						

4 PROCESSOR MODULES

INGESYS[™] IC3 processor modules ensure the right solution in terms of performance and robustness at competitive prices for each application field.

A compact design makes it possible to integrate the most demanding control functionalities (LAN, fieldbus, memory storage, USB, etc.) and ensures the fulfillment of the most demanding industrial requirements.

The different *INGESYS*[™] IC3 processor modules are application software compatible enabling the optimization of software development resources.

The CODESYS-based programming tool with the five IEC61131 programming languages (IL, ST, SFC, LD, FBD), the advanced programming tools (MATLAB®/SIMULINK®, C++) and a powerful range of application-specific software libraries provide the control engineer with the right tool for each requirement.

References					
IC3101 Pentium-based high-performance processor module					
IC3121	ARM-based medium-performance processor module, extended temperature range				

4.1 IC3101 PROCESSOR MODULE

The IC3101 processor modules enable maximum INGESYS™ IC3 functionality and performance, offering a state-of-the-art solution for industrial automation.

These processor modules optimally integrate the real-time control characteristics and robustness of industrial PLCs, with advanced control functional features based on PC technology standards (data management, embedded web servers, communications protocols, etc).

Their compact, robust design makes is possible to work in an extensive temperature range thanks the passive cooling elements.

Different communication interfaces allow INGESYS™ IC3 to be integrated with redundant Ethernet networks, remote I/O extensions and RS232/RS485 communication links.

CHARACTERISTICS

- x86 500Mhz processor •
- 2/4 Ethernet interfaces (10/100) •
- 1 USB host interface •
- 1 RS232C serial interface
- 4MB RAM for user application .
- 10MB internal Flash for user application •
- 62KB NVRAM .
- CF slot for user data
- TEST/ON/OFF switch and status LEDs •

Optional

- **RTSX** interface •
- CAN port
- **IRIG-B** interface
- 8/16 TSX channels (local IO) •

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References					
IC3101AA	2 Ethernet, RS-232C				
IC3101BA 2 Ethernet, RS-232C, 1 RTSX port (Remote IO),8 TSX channels (Local IO)					
IC3101BB	1 Ethernet, 8 TSX channels (Local IO)				
IC3101BD	2 Ethernet, RS-232C, 8 TSX channels (Local IO), 1 CAN port				
IC3101CA	2 Ethernet, RS-232C, 1 RTSX port (Remote IO),16 TSX channels (Local IO)				
IC3101CC	4 Ethernet, RS-232C, 1 RTSX port (Remote IO),16 TSX channels (Local IO), IRIG-B				



	IC3101AA	IC3101BA	IC3101BB	IC3101BD	IC3101CA	IC3101CC	
Functional							
CPU	500Mhz Pentium Compatible						
RAM Memory	RAM Memory 4Mbytes						
NVRAM Memory			62K	bytes			
Internal Flash Memory			10MB for us	er application			
CF Slot			CF without s	ize restriction			
Ethernet	2 x 10/10	00 BaseTX	1 x 10/100 BaseTX	2 x 10/10	00 BaseTX	4 x 10/100 BaseTX	
Serial	1 x R	S232C	NO		1 x RS232C		
USB			1 x USB	2.0 Host	-		
CAN		NO		1	N	10	
TSX	NO		8 channels		16 ch	annels	
RTSX	NO	1 x RTSX port	N	10	1 x RT	SX port	
IRIG-B			NO			1 x IRIG-B	
Electrical							
Power Supply			+3,3V / 5,0V f	rom backplane			
Power Consumption 3,3 V				0,75A (typ.)			
Power Consumption 5,0 V			1,5A (max.) /	′ 1,125A (typ.)			
Max.Dissipated Power			11	IW			
Additional Descript	ions						
Watchdog/ Self Diagnostics							
Real-time clock with lithium b	battery						
3 position working mode swit	tch (TST/ON/OFF)						
3 status indication LEDs							
Internal temperature supervis	sion						
Autodiagnostics							
Hot Swap							
Mechanical							
Dimensions (WxHxD)	imensions (WxHxD) 78,5mm x 175mm x 150,5mm						
Neight 1023g							
Climatic							
Operating Temperature							
Storage Temperature	-40°C to + 85°C						
Relative Humidity							
Accessories (Not included)							
IC3581: COMPACT FLASH							
IC3582: COMPACT FLASH							
IC3583: COMPACT FLASH 2GB							

4.2 IC3121 PROCESSOR MODULE

The IC3121 processor modules are designed for medium-performance control applications with communications requirements in demanding environmental situations.

The software is compatible with the IC3101xx processor and can also work with *INGESYS™* IC3's modules. (I/Os, counter modules, communications modules, etc) offering the same control architecture.

Based on ARM processors, these modules make it possible to work in extreme temperature conditions given their very low power dissipation.

IC3121 modules have a built-in power supply, capable of feeding power to the backplane, eradicating the need for a power supply module.

This family is also capable of communicating via TSX with local IO modules, as well as communicating with remote modules via RTSX. These processor modules also have a built-in Ethernet switch, which can reduce network infrastructure costs in the installation.

CHARACTERISTICS

- ARM 400Mhz processor
- RTSX interface
- 2 Ethernet interfaces (10/100)
- 1 USB host interface
- CAN interface
- 1,4MB RAM
- 2MB for user Application
- 62KB NVRAM
- TEST/ON/OFF switch and status LEDs

Optional

• RS232C/485

References					
IC3121CA 4 TSX channels (Local IO), 1 RTSX port (Remote IO), CAN port Versatile Link, Power Su					
IC3121CB 4 TSX channels (Local IO), 1 RTSX port (Remote IO), CAN port Versatile Link, 2 Serial ports (RS232/485), Power Supply					
IC3121EA	4 TSX channels (Local IO), 2 CAN ports , Power Supply				
IC3121FA	8 TSX channels (Local IO), 2 CAN ports , NO Power Supply				



	IC3121CA	IC3121CB	IC3121EA	IC3121FA			
Functional							
CPU			400Mhz ARM				
Program memory		21	/IB for user application				
RAM memory			1,4MB				
NVRAM memory		62	KB for user application				
Ethernet		2 x 10/10	0 BaseTX (internally swit	itched)			
Serial	-	2 x RS232C/RS485	-	-			
CAN	1 x Optical V	/ersatile Link		2 x D-SUB 9			
USB			1 x USB 2.0 Host				
TSX		4 channels	•	8 channels			
RTSX	1 x RT	SX port	-	-			
Electrical							
Input Voltage		11Vdc to 34Vdc		+3,3V / +5,0V (from backplane)			
In much Comment		0,9A		+3,3V: 0,7A (max.) / 0,575A (typ.)			
Input Current	(depend	Is on output power to	backplane)	+5,0V: 0,1A (max.) / 0,050A (typ.)			
Output Voltage	3	3,3V / 5,0V (to backpla	ane)	_			
Max. Total Output		4W (Shared between 3,3V and 5,0V)		-			
Power	400 (S	nared between 3,3V a	and 5,0V)				
Max. Output current	Max. total out	tput power must be ta	ken into account	-			
3,3 V 1,1A				-			
5,0 V	0,7A			-			
Max. Dissipated Power	4W		2,5W				
Isolation	1000V		-				
Additional Feature	S						
Watchdog							
Real-time clock with Lithiu							
3 position working mode s	witch (TST/ON/OFF)						
3 Status indication leds							
Internal temperature supe	rvision						
	Mechanical						
Dimensions (WxHxD)	n						
Weight	540gr						
Climatic							
Operating Temperature			-40°C to + 70°C				
Storage Temperature -40°C to + 85°C							
Relative Humidity		5%	to 95% w/o condensing				
Accessories (Not	included)						
	IC3565: DC Pov	ver Input Plug		-			

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5 DIGITAL INPUT / OUTPUT MODULES

INGESYS[™] IC3 PAC incorporates a complete set of digital input/output modules to access process signals.

The requirements of different application sectors have been considered, enabling a scalable and optimised solution.

These modules are designed to fulfill demanding industrial environmental conditions, following international standards.

References	
IC3311AAB	32 inputs 24Vdc with diagnosis
IC3312AAB	32 inputs 24Vdc with diagnosis. SoE recording
IC3313AAC	32 inputs. 110/125Vdc, SoE recording
IC3331AAB	32 outputs solid state relay (HSD) with diagnosis
IC3333AAB	32 x 24Vdc Dos HSD 250mA (20 DOs in 5 groups with a common in each group + 12SDs independent common)
IC3335	16 outputs relay (NO) without diagnosis
IC3335BB	16 outputs relay (8NO + 8NC) without diagnosis
IC3393AAB	16 inputs, 16 outputs solid state relays (HSD) 24Vdc with diagnosis
IC3396AA	8 inputs 24Vdc, 4 outputs relay (NO) with diagnosis
IC3396BA	8 inputs 48Vdc, 4 outputs relay (NO) with diagnosis
IC3396CA	8 inputs 125Vdc, 4 outputs relay (NO) with diagnosis
IC3396DA	8 inputs 250Vdc, 4 outputs relay (NO) with diagnosis

5.1 DIGITAL INPUT MODULES

CHARACTERISTICS

- High density modules. Up to 32 inputs in one-slot width
- Self diagnosis
- Digital configurable input filters

Optional

References IC3311AAB

IC3312AAB

IC3313AAC

- 24Vdc rated voltages
- 110/125Vdc rated voltages

32 inputs, 110/125Vdc, SoE recording

• Sequence-of-event recording (SoE)

32 inputs, 24Vdc with diagnosis	
32 inputs, 24Vdc, with diagnosis, SoE recording	



	IC3311AAB	IC3312AAB	IC3313AAC		
Functional					
Number of inputs 32					
Connection mode	One comr	mon return	One common return		
Connection mode	for all the	e signals	for each of the 16 inputs block		
Input polarity	pos	itive	positive / negative		
SoE recording	No		Yes		
Input filter	RC	Digital co	onfigurable. 1ms to 200ms		
Self diagnosis	TSX Internal b	ous and inputs	Only on internal bus TSX		
Hot Swap		Yes			
Input to TSX time	2ms (max.)		Filter Time		
Electrical					
Isolation input to system		2500Vac, 6	60s		
Isolation between inputs	No		2500Vac 60s		
			between the two 16 input blocks		
Rate voltage	24	/dc	110 / 125Vdc		
Low level	OV to	o 11V	0 to + 67V		
High level	18V t	o 30V	+ 77V to + 162V		
Input current	5,5mA (ty	p.) @ 24V	1,6mA @125V		
TSX bus 3,3V supply	160mA (max.)	/ 110mA (typ.)	230mA (max.) /160mA (typ.)		
Mechanical					
Dimensions (WxHxD)	26mm x 175m	ım x 130,4mm	52mm x 175mm x 130,4mm		
Weight		Og	250g		
Slot width	1 slot. IG	C3/TSX	2 slot. IC3 / TSX		
Climatic					
Operating Temperature	-40°C to + 70°C				
Storage Temperature	-40°C to + 85°C				
Relative Humidity	5% to 95% w/o condensing				
Accessories (Not					
Field connection options	Spring terminal plug, 1,5mm ² (2 IC3571 per module) 50 pin flat cable adapter (1 IC3573 per module)		Screw terminal plug, 2,5 mm ² (2 IC3595 per module)		

5.2 DIGITAL OUTPUT MODULES

CHARACTERISTICS

- High density modules
- Self diagnosis. Failure detection on each output
- Short-circuit protection
- Overheating protection

Optional

- 32 solid state 24Vdc outputs
- 16 electromechanical relay outputs



References	
IC3331AAB	32 solid state outputs
IC3333AAB	32 x 24Vdc DOs HSD 250mA (20 DOs in 5 groups with a common in each group + 12SDs independent common)
IC3335	16 outputs relay (NO) without diagnosis
IC3335BB	16 outputs relay (8NO + 8NC) without diagnosis

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	IC3331AAB	IC3333AAB	IC3335	IC3335BB		
Functional						
Number of outputs	32		16	8NO + 8NC		
Connection mode	Two groups of 16 outputs with separate supply Common high side drive	5 different groups of 4 digital output with a common in each group + 12SDs independent	16 Normally open (NO), potential free contacts	8 Normally open (NO), 8 Normally close, potential free contacts		
Self diagnosis	TSX internal bus	and outputs	TSX internal bus	and relay coils		
Hot Swap		Yes	8			
TSX to output time	2ms (ma	ax.)	75ms (n	nax.)		
Operating rate	1Khz (ma	ax.)	5Hz (Full	load)		
Electrical						
Output technology	Solid state relay (SSF	R) opto isolated	Electromecha	nical relay		
Isolation output to system	2500Vac,	60s	2500Vac	c, 60s		
Isolation between outputs	No		2500Vac, 60s			
Breakdown voltage between open contacts	-		1000Vrms			
Aux. supply voltage	24Vdc (rated) 19Vdc (min.), 30Vdc (max.)		-			
Aux. supply current	Sum of all output currents plus 15mA per active output. Limited by a 5A internal fuse per block		-			
Max. current per output	250mA		-			
Switching capacity 24Vdc resistive load	-		8A			
Switching capacity 250Vac resistive load	-		8A			
Max. short circuit current per output	1A, limited by SSR protection		-			
Max. total current per module	5A, limited by internal fuse		-			
Current from 3,3V	Outputs ON: 400mA (max.) / 350mA (typ.) Outputs OFF: 60mA (typ.)		205mA			
Current from 5,0V	-	- 1,5A (max.)				

	IC3331AAB	IC3333AAB	IC3335	IC3335BB			
Mechanical	Mechanical						
Dimensions (WxHxD)	26mm x 175mm x 130,41mm	52,25mm x 175mm x 150,5mm	52mm x 175mm x 130,41mm				
Weight	220g		5360	9			
Slot width	1 slot. IC3	/ TSX	2 slot. IC3	3/TSX			
Climatic							
Operating Temperature	-40°C to + 70°C(extended range)						
Storage Temperature	-40°C to + 85°C						
Relative Humidity	5% to 95% w/o condensing						
Accessories (Not included)							
Field connection options	Spring terminal plug, 1,5mm ² (2 IC3571 per module) 50 pin flat cable adapter (1 IC3573 per module)	13 pin spring terminal socket (4 IC3593 per module)	Screw terminal p (2 IC3595 pe				

5.3 DIGITAL INPUT / OUTPUT MODULES

CHARACTERISTICS

- High density modules
- Self diagnosis capability
- Short-circuit protection
- Over-temperature protection

Optional :

- 16DI + 16DO 24Vdc optocoupler
- 8DI 24Vdc + 4DO relay
- 8DI 48Vdc + 4DO relay
- 8DI 125Vdc + 4DO relay
- 8DI 250Vdc + 4DO relay
- Sequence-of-event recording (SoE)

References	
IC3393AAB	16 inputs + 16 outputs. 24Vdc with diagnosis
IC3396AA	8 inputs 24Vdc + 4 relay outputs with diagnosis
IC3396BA	8 inputs 48Vdc + 4 relay outputs with diagnosis
IC3396CA	8 inputs 125Vdc + 4 relay outputs with diagnosis
IC3396DA	8 inputs 250Vdc + 4 relay outputs with diagnosis



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	IC3393AAB	IC3396AA	IC3396BA	IC3396CA	IC3396DA
Functional					
Number of inputs	16	8			
Connection mode	One common return	One common return			
Input polarity	Positive	All ir	nput with same pol	arity Positive or Neg	ative
Input filter	RC		Digital configura	ble. 1ms to 200ms	
SoE recording	No		١	/es	
Self diagnosis		TSX internal bus	s, inputs and outpu	ıts	
Hot Swap			Yes		
Input to TSX time	2ms (max.)		2ms	(max.)	
Number of outputs	16			4	
Outputs connection mode	Common high side drive		Normally open ((NO) relay outputs	
Internal bus to output time	2ms (max.)		10ms	s (max.)	
Output switching rate	1Khz (max.)		5Hz (F	Full load)	
Electrical					
Inputs					
Isolation input to system	2500Vac, 60s		2500\	/ac, 60s	
Isolation between inputs	No			No	
Input Rated voltage	24Vdc	24Vdc	48Vdc	125Vdc	250Vdc
Input Low level	0V to 11V	0V to 9V	0V to 32V	0V to 82V	0V to 165V
Input High level	18V to 30V	12V to 30V	37V to 60V	87V to 156V	172V to 312V
Input current	5,5mA (typ.) @ 24V	3mA (typ.) @ 24V	2,5mA (typ.) @ 48V	2mA (typ.) @ 125V	2mA (typ.) @ 250V
Power from 3,3V	160mA (max.) / 110mA (typ.)		185mA (max.) / 169mA (typ.)	<u> </u>
Outputs		•			
Output technology	Solid state relay (SSR) opto isolated		Electro med	chanical relay	
Isolation output to system	2500Vac, 60s		2500\	/ac, 60s	
Isolation between outputs	No		2500\	/ac, 60s	
Breakdown voltage between open contacts	-		100	0Vrms	
Switching capacity 24Vdc resistive load	-	8A			
Switching capacity 250Vac resistive load	-	8A			
Aux. supply voltage	24Vdc (rated) 19Vdc (min.), 30Vdc (max.)	-			
Aux. supply current	Sum of all the output currents plus 15mA per active output Limited by 5A internal fuse	-			
Max current per output	250mA	-			
Max short circuit per output	1A, limited by SSR protection	-			
Max total per module	5A, limited by internal fuse	-			

	IC3393AAB	IC3396AA	IC3396BA	IC3396CA	IC3396DA
Electrical					
Outputs					
Power from 3,3V	Outputs ON:400mA (max.) / 350mA (typ.) Outputs OFF: 60mA (typ.)	180mA (max.) / 160mA (typ.)			
Current from 5,0V	-		300mA (max.)) / 263mA (typ.)	
Mechanical					
Dimensions (WxHxD)		26mm x 175	mm x 130,41mm		
Weight	220g		29)8g	
Slot width		1 slot.	IC3 / TSX		
Climatic					
Operating Temperature		-40°C	to + 70°C		
Storage Temperature	-40°C to + 85°C				
Relative Humidity	5% to 95% w/o condensing				
Accessories (Not included)					
Field connection options	Spring terminal plug.1,5mm ² (2 IC3571 per module) Socket to flat cable adapter (1 IC3573 per module)			Il plug, 2,5 mm² C3570 per module)	

6 ANALOGUE INPUT / OUTPUT MODULES

A set of analogue input/output modules intended for a TSX bus, fully equips IC3 PAC for using analogue process signals.

The requirements of different application sectors have been considered, enabling a scalable and optimized solution.

These modules are designed to fulfill demanding industrial environmental conditions, following international standards.

References	
IC3356AB	16 analogue inputs with +/- 10V and +/- 20mA max input ranges
IC3357AB	16 PT100 inputs 2 wires TSX
IC3358AB	16 PT100 inputs 3 wires TSX
IC3364AA	8 V/I/Pt100/IEPE high speed analogue inputs channels 8 V/I high speed analogue outputs channels
IC3364AC	2 PT100 CH + 2 IEPE high speed analogue inputs channels 2 V/I analogue output channels
IC3364AD	6 V/I/Pt100/IEPE high speed analogue input channels2 Thermocouple analogue input channels8 V/I high speed analogue output channels
IC3364AF	8 V/I/Pt100/IEPE high speed analogue input channels
IC3373AB	16 outputs with +/- 10V and +/- 20mA max output ranges
IC3374AB	8 outputs with +/- 10V and +/- 20mA max output ranges
IC3394AB	8 channels for accelerometer signal analysis, 8 digital inputs and output, 4 analogue input, 2 fast counter channels and 1 SSI channel

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6.1 ANALOGUE INPUT MODULES

- Fulfill the most demanded analogue measurements in the industry
- High resolution
- Self diagnosis
- High density modules

References	References		
IC3356AB	16 analogue inputs with +/- 10V, +/- 20mA ranges		
IC3357AB	16 PT100 inputs. 2 wires		
IC3358AB	16 PT100 inputs. 3 wires		
IC3364AF	8 V/I/Pt100/IEPE high speed analogue input channels		
IC3394AB	8 accelerometer channels, 8 digital inputs/outputs, 4 analogue input channels, 2 fast counter channels and 1 SSI channel		

-		-	
In	no	to	am
	чc	LC	um

	IC3356AB	IC3357AB	IC3358AB		
Functional					
Input signal	Voltage / Current	PT100 sensor			
Number of inputs	16	16			
Connection mode	Common GND reference	2 wires	2 or 3 wires		
Self diagnosis		TSX and ADC			
Hot swap		Yes			
Measurement ranges	-20mA to +20mA,0 to 20mA, +4mA to 20mA -10V to +10V, -5V to +5V, -1V to +1V 0 + 5V, 0 + 10V	-50°C to 200°C			
Refresh time	5,2ms (max.)		48ms (max.)		
A/D converter		16 bits			
Electrical	_				
Break down current in current mode	+/- 40mA		-		
Break down voltage	+/- 18V		-		
Open circuit voltage	-		3,4V (max.)		
PT100 current	-		1,6mA (max.)		
Isolation input to system	1500Vac, 60s				
Isolation between inputs		No			
Input impedance, voltage mode	>33ΚΩ	-			
Input impedance, current mode	440Ω (min.), 460Ω (max.)		-		
TSX bus current from 3,3V	550mA (max.) / 430mA (typ.)	600mA (max.) / 400mA (typ.)			
Current from 5,0V		-			
Mechanical	_				
Dimensions (WxHxD)	2	6mm x 175mm x 130,41r	nm		
Weight	210g	250g			
Slot width		1 slot. IC3 / TSX			
Climatic					
Operating Temperature	-40°C to + 70°C				
Storage Temperature	-40°C to + 85°C				
Relative Humidity	5% to 95% w/o condensing				
Accessories (Not					
Field connection options	Spring terminal plug, 1,5mm ² (2 IC3571 per module) Socket to flat cable adapter (1 IC3573 per module)	Spring terminal plug, 1,5mm ² (4 IC3593 per module)			

	IC3364AF		
Functional			
Number of Inputs	8		
Input type and ranges			
Voltage	+/-10V , +/-5V , +/-1V , 0 to 10V , 0 to 5V		
Current	+/-20mA , 0 to 20mA , 4 to 20mA		
Pt100 sensor	-50C to 200C		
IEPE sensor	+/-5V , +/-1V		
Input connection	Differential for voltage ranges, Single ended for current, Pt100 and IEPE		
Refresh time (CoDeSys)	1.5ms		
Max. Sampling rate (Simulink®)	100Ksamples/s		
Input resolution	Up to16bits		
Electrical			
Isolation			
Front connector to system connector	1500Vdc 1min		
Front connector to earth	1500Vdc 1min		
Max Input voltage	+/- 15V from any Aln(+/-) input to M point		
Input Impedance			
Voltage mode	>500ΚΩ		
Current mode	440Ω typ		
Aux. supply voltage	24Vdc +/- 10%		
Aux. supply current	250mA (max.) / 150mA (typ.) @ 24Vdc		
Current from TSX			
3,3V	400mA (max.) / 250mA (typ.)		
5,0V	-		
Mechanical			
Dimensions (WxHxD)	26mm x 175mm x 130,41mm		
Weight	275g		
Slot width	1 slot. IC3 / TSX		
Climatic			
Operating Temperature	-40°C to + 70°C (extended range)		
Storage Temperature	-40°C to + 85°C		
Relative Humidity	5% to 95% w/o condensing		
Accessories (Not include	d)		
Field connection options	Spring terminal plug, 1,5mm ² (4 IC3593 per module)		

IC3394AB				
Functional				
Accelerometer inputs				
Input signal	IEPE standard (ICP) Accelerometer			
Input channels	8			
Connection signals	ASx, AGx, ⊥ (signal, ref. screen)			
Sampling frequency	47,971492Khz			
Connection mode	Single ended			
Configurable gains G, (dB)	0, 3, 6, 9, 12, 20, 23, 26, 29, 32			
Resolution	24bits			
Sensitivity	10V p-p a G=0db at full scale			
Dynamic range	106,5dB (typ.)			
Useful band	0,1Hz to 21Khz			
Sensor diagnostics	Yes			
Current injected to sensor	4mA (typ.)			
Self diagnosis	-			
Hot Swap	-			
Analogue inputs				
Input channels	4			
Input signal types	Voltage / Current			
	-20mA to +20mAa, 0 to 20mA, +4mA to 20mA			
Measurement ranges	-10V to +10V, -5V to +5V, -1V to +1V			
Defecels fires	0 to + 5V, 0 to + 10V			
Refresh time	1,6ms (max.)			
Resolution	16 bits			
Break down current in current mode	+/- 40mA			
Break down voltage	+/- 18V			
Isolation input to system	1500Vac, 60s			
Isolation between inputs	No			
Input impedance, voltage mode	>33ΚΩ			
Input impedance, current mode	440Ω (min.), 460Ω (max.)			
Digital inputs/outputs				
Input/output channels	8			
Input connection mode	One common return for all the signals			
Input low level	0V to 11V			
Input high level	18V to 30V			
Input current	5,5mA			
Output technology	Solid state relay opto isolated			
Max current per output	250mA			
Fast counter inputs				
Counter channels	Two channels, each with three signals: A0, B0, G0 / A1, B1, G1			
SSI Interface				
Interface	SSI standard			

	IC3394AB		
Electrical			
24V power supply voltage for IEPE inputs (PSA power supply)	24Vdc, +/- 10%		
PSA power supply consumption	250mA (max.) / 125mA (typ.)		
Mechanical			
Dimensions (WxHxD)	52mm x 175mm x 130,41mm		
Weight	225g		
Slot width	1 slot. IC3 / TSX		
Climatic			
Operating Temperature	-40° to +70°C		
Storage Temperature	-40°C to +85°C		
Relative Humidity	5% to 95% w/o condensing		
Accesories (Not Included)			
Field connection options Spring terminal plug.1,5mm² (4 IC3571 per m			

6.2 ANALOGUE OUTPUT MODULES

- Voltage or current outputs. Software configurable
- Output status diagnosis
- Short-circuit protection
- Overheating protection



References	
IC3373AB	16 outputs with +/- 10V and +/- 20mA
IC3374AB	8 outputs with +/- 10V and +/- 20mA

	IC3373AB	IC3374AB	
Functional			
Number of outputs	16	8	
Connection mode	Common GND reference		
Self diagnosis	TSX a	nd ADC	
Hot Swap	Y	⁄es	
Output signal	•	/ Current	
Output ranges		to +10V, 0 to +5V o 20mA, +4mA to 20mA	
Refresh time	2,5ms	s (max.)	
A/D converter bits		16	
Electrical			
Aux. supply voltage	24V -	+/- 10%	
Aux. supply current	370mA (max.) , wit	h all outputs at 20mA	
Isolation output to system	1500Vac, 60s		
Isolation between outputs	No		
Resistive load in voltage mode	1KΩ (min.)		
Resistive load in current mode	500Ω (max.)		
Current from 3,3V	160mA (max.) / 115mA (typ.)		
Mechanical			
Dimensions (WxHxD)	26mm x 175mm x 130,41mm		
Weight	2	230g	
Slot width	1 slot. IC3 / TSX		
Climatic			
Operating Temperature	-40°C to + 70°C		
Storage Temperature	-40°C to + 85°C		
Relative Humidity	5% to 95% w/o condensing		
Accessories (Not incl	uded)		
Field connection options	Spring terminal plug.1,5mm ² (2 IC3571 per module) Socket to flat cable adapter (1 IC3573 per module)	Spring terminal plug.1,5mm ² (2 IC3574 per module) Socket to flat cable adapter (1 IC3578 per module)	

6.3 ANALOGUE INPUT / OUTPUT MODULES

- Fast acquisition rate up to 100Ks/sec
- iTSX compliant. Intended for fast control application
- High resolution ADC and DAC, up to 16 bits
- Differential inputs
- Analogue Input mode (V/I/Pt100/IEPE) software configurable
- Analogue Output mode (V/I) software configurable

References	
IC3364AA	8 V/I/Pt100/IEPE high speed analogue inputs channels 8 V/I high speed analogue outputs channels
IC3364AC	2 PT100 CH + 2 IEPE high speed analogue inputs channels 2 V/I analogue output channels
IC3364AD	6 V/I/Pt100/IEPE high speed analogue input channels2 Thermocouple analogue input channels8 V/I high speed analogue output channels

	IC3364AA	IC3364AC	IC3364AD			
Functional						
Number of Inputs	8		6+2			
Input type and ranges						
Voltage	+/-10V , +/-5V , +/-1V , 0 to 10V , 0 to 5V					
Current	+	-/-20mA , 0 to 20mA , 4 to 20	mA			
Pt100 sensor	-50C to 200C	-	-50C to 200C			
IEPE sensor	+/-5V , +/-1V	-	+/-5V , +/-1V			
Thermocouple sensor			J: -40°C to 180°C K: -200°C to 230°C T: -200°C to 200°C			
Input connection	Differential for voltage ranges Single ended for current, Pt100 and IEPE	Differential for voltage ranges Single ended for current	Differential for voltage ranges Single ended for current, Pt100, thermocouple and IEPE			
Sampling rate		Up to 100Ks/sec				
Input resolution		Up to16bits				
Number of outputs	8	-	8			
Output type and range						
Voltage		DV , +/-5V , +/-1V , 0 to 10V ,				
Current	+	/-20mA , 0 to 20mA , 4 to 20	ImA			
Isolation						
Front connector to system connector	1500Vdc 1min					
Front connector to earth	1500Vdc 1min					
Max Input voltage	+/- 15V from any Aln(+/-) input to M point					
Input Impedance						
Voltage mode	>500ΚΩ					
Current mode	440Ω typ					
Output max load						
Voltage mode	1KΩ (min.)	-	1KΩ (min.)			
Current mode	500Ω (max.)	-	500Ω (max.)			
Aux. supply voltage	24Vdc +/- 10%					
Aux. supply current	450mA (max.) / 310mA (typ.) @ 24Vdc					
Current from TSX						
3,3V	400mA (max.) / 250mA (typ.)					
5,0V	-					
Mechanical						
Dimensions (WxHxD)	26mm x 175mm x 130,41mm					
Weight	275g					
Slot width		1 slot. IC3 / TSX				
Climatic						
Operating Temperature	-40°C to + 70°C (extended range)					
Storage Temperature	-40°C to + 85°C					
Relative Humidity	5% to 95% w/o condensing					
Accessories (Not include	d)					
Field connection options	Spring termi	nal plug, 1,5mm ² (4 IC359	93 per module)			

7 FIELDBUS COMMUNICATION MODULES

Distributed automation solutions based on open field buses are the current standard for many sectors in the manufacturing industry and more recently, for process engineering. Field buses permit full utilization of the functional advantages of digital communication, such as improved resolution in measured values.

INGESYS[™] IC3 PAC offers a wide range of fieldbus-compatible modules, covering the entire scope of process and manufacturing automation.

References	
IC3261AB	CANopen Master. 2 Ports 9-pin male D-Sub. Extended temperature range
IC3262A	CANopen Master. 2 Optical fibre ports
IC3262AB	CANopen Master 1 x Optic fibre port + 1 x Copper DB9 connection
IC3262B	CANopen Master. 1 Optical fibre port
IC3262BB	CANopen Master. 1 Optic fibre port. Extended Temperature Range
IC3281	Interbus-S Master module
IC3282A	Interbus-S Slave module. Copper
IC3282B	Interbus-S Slave module. Optical fibre
IC3271	Profibus DP Master module
IC3272AA	Profibus DP Slave module
IC3291	MVB Multifunction Vehicle Bus. Train Communication Network (TCN)
IC3292A	WTB Wire Train Bus. Train Communication Network (TCN)
IC3293A	Profinet Slave 2-port (switched)



7.1 CANOPEN MASTER MODULES

IC326X modules incorporate the CANopen master functional feature in *INGESYS*[™] IC3, following the profiles given in the CiA 301 specification released by <u>CAN in Automation</u>. The use of CANopen eases technical details, simplifying the control engineer's task of developing the application and improving reliability.

- CANopen master modules
- Copper or optical fibre
- Max. transmission speed 1Mbit/s
- Hot Swap
- Extended temperature



References	
IC3261AB	CANopen Master. 2 Ports 9-pin male D-Sub. Extended temperature range
IC3262A	CANopen Master. 2 Optical fibre ports
IC3262AB	CANopen Master. 1 Optical fibre port + 1 9-pin male D-Sub Port
IC3262B	CANopen Master. 1 Optical fibre port
IC3262BB	CANopen Master. 1 Optical fibre port. Extended Temperature Range

	IC3261AB	IC3262A	IC3262AB	IC3262B	IC3262BB	
Functional						
Communication Protocol	CANopen					
Number of channels		2		1		
Connection type	DB9 male	V-pin connector	1 x V-pin connector	V-pin connector		
			1 xx DB9 male			
Physical medium	Copper	POF or HCS optical fibre	POF or HCS optical fibre	POF or HC	S optical fibre	
		optical libre	Copper			
	Up to 1Mbit/s		1Mbit/s			
Max. transmission speed	(Cable length dependent)	1Mbit/s	Up to 1Mbit/s (Cable length dependent)	1Mbit/s		
Hot Swap		Yes				
Diagnostic LEDs	Yes					
Electrical						
Data link and physical layer	CAN					
Power supply consumption						
3,3V	250mA (max.) / 230mA (typ.)	170mA (max.) /	140mA (typ.)	160mA (max.) / 130mA (typ.)	
5,0V	50mA (max.) / 30mA (typ.)	230mA (max.) / 2	210mA (typ.)	110mA (max.) / 105mA (typ.)	
Self diagnosis	Yes					
Mechanical						
Dimensions (WxHxD)	26mm x 175mm x 130,41mm					
Weight	205g	192g 195g		190g		
Slot width	1 slot. IC3 /TSX					
Climatic						
Operating Temperature	-40°C to + 70°C					
Storage Temperature	-40°C to + 85°C					
Relative Humidity	5% to 95% w/o condensing					
7.2 INTERBUS-S COMMUNICATIONS

INTERBUS is an open fieldbus network, standardised in the international standard IEC 61158. It is designed as a fast sensor / actuator network for transmitting cyclic process data in industrial environments

INGESYS[™] IC3 incorporates the INTERBUS-S master and slave functional feature for its optimal integration into process automation.

- Interbus S master and slaves modules
- Copper, optical fibre
- Hot Swap
- Extended temperature





	IC3281	IC3282A	IC3282B
Communication Protocol	INTERBUS-S		
Functionality	Master Slave		
Number of channels	1	1 (Input	- output)
Connection type	DB9 female	Ingoing DB9 male / Outgoing DB9 female	V-LINK Connector
Physical medium	Copper	Copper	POF or HCS optical fibre
Max. transmission speed		500Kbps	
Hot Swap		Yes	
I/O Interbus-S No. Bytes	4096 input & 4096 outputs	2 to	9 64
Max. No. Slave Devices	512 -		
Electrical			
Power supply consumpti	on		
3,3V	330mA (max.) / 280mA (typ.)	600mA (max.) / 560mA (typ.)	440mA (max.) / 400mA (typ.)
5,0V	260mA (max.) / 220mA (typ.)	130mA (max.) /100mA (typ.)	320mA (max.) / 290mA (typ.)
Dissipated power	1,4W (max.)	2,7W (max.)	3,3W (max.)
Galvanic separation	500 VAC for 1 n	nin between IBS connectors and	internal circuits
Isolation technology		Optical couplers	
Self diagnosis		Yes	
Mechanical			
Dimensions (WxHxD)		26mm x 175mm x 130,41mm	
Weight	240g	21	1g
Slot width	1 slot. IC3 / TSX		
Climatic			
Operating Temperature	-40°C to + 70°C		
Storage Temperature	-40°C to + 85°C		
Relative Humidity	5% to 95% w/o condensing		

7.3 TRAINBUS COMMUNICATIONS (TCN) MODULES

The Train Communication Network (TCN) defined in the IEC61375-1 standard is applied in trains in order to facilitate communication between devices and different wagons. This protocol standard founded by the International Electrotechnical Committee (IEC) is used to transfer information concerning train control, diagnostics and passenger information.

TCN is an embedded real-time data network proposed for use on trains [IEC99], and consists of two different networks with somewhat different protocols: The Multi- function Vehicle Bus (MVB) protocol is used for networks within a single vehicle, while the Wire Train Bus (WTB) is used across the length of an entire train.

Modules IC3291 and IC3292 incorporate these two protocols in *INGESYS™* IC3.

- Two redundant channels
 - MVB. Multifunction Vehicle Bus
 - Optical fibre connection
 - Bus administrator capacity
- WTB.Wire Train Bus
 - Supporting the UIC protocol ("International Union of Railways), according UIC-556 Leaflet)



References	
IC3291	MVB communication module
IC3292A	WTB communication module

	IC3291 IC3292A			
Functional				
Communication Protocol	TCN – MVB – OGF (optical fibre)	TCN – WTB		
Line number	2	2		
Connection type	2 x ST (each line)	2 x D-Sub with 9 pin (each line)		
Physical medium	HCS Multimode 200µm (optical fibre pair)	Shielded twisted pair		
Transmission speed	1,5 Mbit/s	1 Mbit/s		
Hot Swap		Yes		
Status Diagnosis Leds	Yes			
Electrical				
Power supply consumpt	on			
3,3V	500mA (max.) / 360mA (typ.)	210mA (max) / 170mA (typ.)		
5,0V	195mA (max.) / 150mA (typ.)	195mA (max.) w/o fritting / 160mA (typ.) 740mA (max.) with fritting / 630mA (typ.)		
Dissipated Power	2,7W	1,7W (max.) w/o fritting 4,4W (max.) with fritting		
Mechanical				
Dimensions (WxHxD)	26mm x 175mm x 130,41mm	52mm x 175mm x 130,41mm		
Weight	225g	385g		
Slot width	1 slot. IC3 / TSX 2 slots. IC3 / TSX			
Climatic	Climatic			
Operating Temperature	-40°C to + 70°C			
Storage Temperature	-40°C to + 85°C			
Relative Humidity	5% to 95% w/o condensing			

7.4 PROFIBUS DP MODULES

PROFIBUS is suitable for fast communication with distributed I/Os in production automation and for communications tasks in process automation.

It is based on universal international standards and oriented to the OSI (Open System Interconnection) reference model as per international standard ISO 7498.

The PROFIBUS DP fieldbus is established at the field level, where a high-speed response is required and small amounts of data are generally exchanged.

- PROFIBUS DP master Class 1
- Max. Transmission rate 12Mbit/s
- Hot Swap
- Extended temperature

References	
IC3271	PROFIBUS DP Master module
IC3272AA	PROFIBUS DP/DPV1 Slave module



	IC3271	IC3272AA	
Functional			
Communications	PROFIBUS DP Master	PROFIBUS DP Slave	
Number of channels	1		
Connection type	DB9 r	nale	
Physical medium	Сор	per	
Max. transmission speed	12Mt	pit/s	
Hot Swap	Ye	S	
Diagnosis LEDs	Ye	S	
Electrical			
Power supply consumption	pn		
3,3V	180mA (max.) / 120mA (typ.)	200mA (max.) / 185mA (typ.)	
5,0V	450mA (max.) / 320mA (typ.)	-	
Dissipated power	2,65W (max.)	0,68W	
Signals/Autodiagnosis	Yes		
Mechanical			
Dimensions (WxHxD)	26mm x 175mi	m x 130,4mm	
Weight	235g	197g	
Slot width	1 slot. IC3 / TSX		
Climatic			
Operating Temperature	0°C to + 70°C -40°C to + 70°C		
Storage Temperature	-40°C to + 85°C		
Relative Humidity	5% to 95% w/o condensing		

7.5 SERIAL COMMUNICATIONS MODULES

INGESYS[™] IC3 offers different possibilities to interface external devices via serial links. RS232 or RS485 (half or full duplex) or serial optical fibre links with the most standard serial protocols are offered to satisfy the demands of industrial applications.

- Three software-configurable serial ports RS-232/RS-485 (half/full duplex)
- Optical fibre link (POF or HCS) version for demanding EMC environments
- TX/RX LEDs per channel
- Intelligent modules
- FIFO buffer UART



References	
IC3251AB	3 serial RS232/RS485 ports, DB9. Extended Temperature Range
IC3252AB	3 serial port optical fibre link. Extended Temperature Range
IC3252BB	2 serial port optical fibre link. Extended Temperature Range
IC3252DB	2 serial port optical fibre link + 1 Dsub-9 serial port RS232/RS485. Extended Temperature Range

	IC3251AB	IC3252AB	IC3252BB	IC3252DB
Functional				
Communication	Serial RS232/RS485 (Half and Full duplex)	Serial		
Number of ports	3		2	3
Connection type	Female DB9	V-nin	connector	2 x V-pin connector
		v-piii	CONNECTOR	1 x Female DB9
Physical medium	Copper		0m (max.) ibre 300m (max.)	POF 50m (max.) HCS optical fibre 300m (max.)
				Copper
Maximum	RS-232 Up to 64 Kbit/s RS485: Up to	•	o to 500Kbit/s	POF : Up to 500Kbit/s HCS : Up to 500Kbit
transmission speed	500Kbit/s	HCS : U	p to 500Kbit	RS-232 Up to 64Kbit/s RS485: Up to 500Kbit/s
Signals/Diagnosis	Yes			
Transmission LEDs	Yes			
Diagnostic LEDs	Yes			
Electrical				
Power supply consump	otion			
3,3V	420mA (max.) / 400mA (typ.)	170mA (max.) / 160mA (typ.)		220mA (max.) / 210mA (typ.)
5,0V	-	300mA (max.) / 270mA (typ.)	200mA (n	nax.) / 180mA (typ.)
Dissipated power	1,4W (max.)	2 W (max.)	1,6W (max.)	1,8W (max.)
Galvanic isolation	500Vdc between field signals and internal logic			
Isolation technology		Us	ing transformer	
Mechanical				
Dimensions (WxHxD)		26mm x	175mm x 130,41mm	
Weight	220g	197g 194g		210g
Slot width	1 slot. IC3 / TSX			
Climatic				
Operating Temperature			10°C to + 70°C	
Storage Temperature	-40°C to + 85°C			
Relative Humidity	5% to 95% w/o condensing			

7.6 PROFINET SLAVE COMMUNICATION

The IC3293 module provides profinet slave functionality, with integrated 2-port switch and support up to 256 bytes of IO for both Input and Output data for cyclic RT communications.

References		
IC3293A	Profinet Slave 2-port (switched)	

	IC3293A	
Functional		
Communications	PROFINET I/O	
Number of channels	2	
Connection type	RJ45	
Physical medium	Copper	
Diagnosis LEDs	Yes	
Self diagnosis	Yes	
Hot Swap	Yes	
Electrical		
Power supply consumption	500mA (max.) / 3,3V 335mA (typ.)	
Dissipated Power	1,165W(max.)	
Mechanical		
Dimensions (WxHxD)	26mm x 175mm x 130,41mm	
Weight	205g	
Slot width	1 slot. IC3 / TSX	
Climatic		
Operating Temperature	0°C to + 70°C	
Storage Temperature	-40°C to +85°C	
Relative Humidity	5% to 95% w/o condensing	

8 COUNTER MODULES

The counter function modules are designed to manage binary signals with high frequency rates.

Different counter modules are available integrating different functional features and additional I/Os.

- Three types of incremental encoders
- Up to 2 Million counts per second
- Fully configurable counters: set-points, presets, etc.
- High resolution position and speed measurements

References	
IC3325AB	6 general-purpose configurable counters
ICJJZJAB	Position and speed measurement by pulse encoders
IC3391A	6 counters for speed measurement by pulse encoders
	4 analogue outputs (+/- 10V)
IC3391AB	6 counters for speed measurement by pulse encoders
	4 analogue outputs (+/- 10V). Extended Temperature Range
	3 SSI interface for absolute position encoder
IC3392BB	4 digital inputs
10333200	2 digital outputs (relay)
	4 analogue outputs (4 to 20 mA)



	IC3325AB IC3391A IC3391AB			IC3392BB
Functional				
Number of counters	6			-
SSI interface		-		3
Encoders supported	A, B signals phase shifted 90° A for up and B for down A for count and B for up/down		SSI	
Number of signals	6 A/B pa	airs + 8 (general p	urpose)	3 A/B pairs
Count speed	2	2 x 10 ⁶ counts/se	C	-
Electrical				
Counter Signals standard		24V HTL		-
SSI signals		-		RS485
Isolation input to system	2500Vac, 60s			1500Vac, 60s
Isolation between inputs			No	
Current from 3,3V	250mA (max.)		Outputs ON: 400mA (max.) / 350mA (typ.) Outputs OFF: 72mA (max.) / 60mA (typ.)	
Mechanical	Mechanical			
Dimensions (WxHxD)	26mm x 175mm x 130,41mm 52,25mm x 175mm x 130,41mm			52,25mm x 175mm x 130,41mm
Weight	220g			
Slot width	1 slot. IC3 / TSX			
Climatic				
Operating Temperature	-40°C to + 70°C	0°C to + 70°C		-40°C to + 70°C
Storage Temperature	-40°C to + 85°C			
Relative Humidity	5% to 95% w/o condensing			
Accessories (Not included)				
Adapter module for Grid Measurements module (AC0179) connection to IC3391A. Ref. IC7036 IC7036 <-> IC3391A connection cable. Ref. IC3590 Field connection options: Spring terminal plug.1,5mm ² . (2 IC3571 per module) Socket to flat cable adapter. (1 IC3573 per module)				

9 RTSX EXPANSION BUS

The RTSX is a proprietary bus on which *INGESYS™* IC3's distributed topology is based.

A 10Mbits transmission rate and exhaustive diagnostics features ensure the system's integrity, reliability and determinism.

The bus expansion follows a nested star topology with up to two sublevels and up to 256 remote I/Os units can be connected by an optical fibre link (plastic or HCS).

Two different components integrate the bus: the router modules that enable bus expansion, and header modules that integrate I/O expansion racks in the RTSX bus. The processors modules incorporate RTSX master ports to directly access a remote expansion I/O unit incorporating an RTSX header module.

References	
IC3201AB	Header module 16 slots without built-in power supply
IC3202AB	Header module 8 slots with built-in power supply
IC3221	Router RTSX 1M-4S
IC3222B	Router RTSX 2M-4S

9.1 HEADER MODULES

The header modules are a component *INGESYS*^{imestarrow} IC3 PAC's distributed architecture. They make it possible to add remote I/Os units that expand the central unit when a larger number of inputs/outputs than those permitted by a local set is required, or when a distributed input/output configuration is needed.

Communication between central rack and remote racks is based on the RTSX master-slave proprietary bus, an optical fibre bus (POF for distances up to 50m or HCS fibres for distances up to 200m) that guarantees robust and real-time communication between the central processors and modules located in remote racks.

There are various header modules available, depending on the maximum slot number and the incorporation of rack power supply

References	
IC3201AB	Header module 16 slots without built-in power supply
IC3202AB	Header module 8 slots built-in without power supply



	IC3201AB	IC3202AB		
Functional				
Communications	RT	SX		
Number of ports	1			
Max. Transmission speed	10M	bit/s		
Max. Installation distance per section	50m for POFs,	200m for HCS		
Diagnosis LEDs	Ye	es		
Electrical				
Connection type	Versatile Link (V-LINK)			
Max. Number of TSX slaves	16	8		
Built in rack power supply	No	Yes		
Max. Output current to backplane				
3,3V	-	2,5A		
5,0V	-	1,75A		
Power Supply Consumption				
In 3,3 V	900mA (max.)	800mA (max.)		
Mechanical				
Dimensions (WxHxD)	52mm x 175mr	n x 130,41mm		
Weight	450) g		
Slot width	2 slot. IC	3 / TSX		
Climatic				
Operating Temperature	-40°C to	+ 70°C		
Storage Temperature	-40°C to	+ 85°C		
Relative Humidity	5% to 95% w/o condensing			

9.2 TSX STAR COUPLER

The IC3222B "RTSX 2M-4S Star coupler" permits the connection of 2 RTSX master modules and the expansion of the RTSX Bus up to 4 slave channels.

The communication channels are via optical fibre with V_LINK type connectors. It supports up to 10Mbit/s.

Each channel incorporates a status indication LED.



References		
IC3221	Router RTSX 1M-4S	
IC3222B	Router RTSX 2M-4S	

	IC3221	IC3222B		
Functional				
Configuration	1 INGESYS™ IC3 controller accessing 4 remote I/Os racks	Up to 2 INGESYS™ IC3 controllers accessing 4 remote I/Os racks		
Max. Transmission speed	10Mbit/s			
Max. Installation distance per section	section 50m for POFs, 200m for HCS			
Diagnosis LEDs per channel	Yes			
Electrical				
Average power consumption	3,5Watts			
Power supply voltage (rated)	18-30VDC			
Mechanical				
Dimensions (WxHxD)	125mm x 161mm x 40mm			
Weight	189g			
Mounting	DIN rail			
Climatic				
Operating Temperature	-40°C to +70°C			
Storage Temperature	-40°C to +85°C			
Relative Humidity	5% to 95% w/o condensing			

10 ACCESSORIES

References		
IC3598A	32 PONTS INTERFACE + PS DISTRIBUTION NO SWITCHABLE W/O FUSES. PLASTIC ENCLOSURE	
IC3565	DC POWER INPUT PLUG FOR IC3121XX	
IC3571	18 PIN TERMINAL PLUG (max. CABLE SECTION 1,5mm ²)	
IC3573	TERMINAL SOCKET/ FLAT CABLE ADAPTER (32 POINTS)	
IC3574	10 PIN TERMINAL PLUG (max. CABLE SECTION 1,5 mm ²)	
IC3575	TSX SLOT COVER	
IC3582	COMPACT FLASH 1GB	
IC3583	COMPACT FLASH 2GB	
IC3596	COMPACT FLASH 4GB	
IC3590	CONNECTION CABLE: AC0179 MODULE IC3391-A MODULE: Options:	
IC3593	13 PIN SCREW TERMINAL PLUG (max. CABLE SECTION 2,5mm ²)	
IC3595	18 PIN SCREW TERMINAL PLUG (max. CABLE SECTION 2,5mm ²)	
IC7036	ADAPTER TO CONNECT: AC0179 MODULE IC3391-A MODULE	

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